

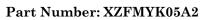
## **Features**

- 0.2 inch digit height
- Robust package
- Low power consumption
- Standard configuration: Gray face w/ white segments
- Standard Package: 300pcs/ Reel
- MSL (Moisture Sensitivity Level): 2a
- RoHS Compliant

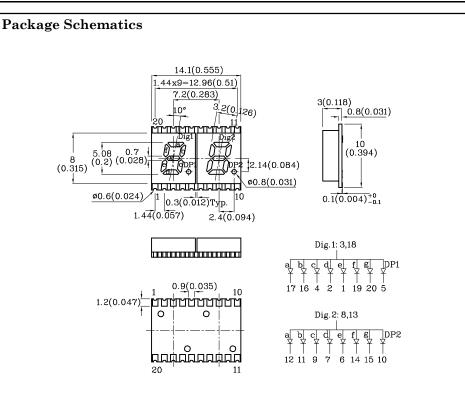




ATTENTION OBSERVE PRECAUTIONS FOR HANDLING ELECTROSTATIC DISCHARGE SENSITIVE DEVICES



## Surface Mount Display





1. All dimensions are in millimeters (inches), Tolerance is  $\pm 0.25(0.01")$  unless otherwise noted.

2. Specifications are subject to change without notice.

3. The gap between the reflector and PCB shall not exceed 0.25mm.

Absolute Maximum Ratings (T <sub>A</sub> =25°C)		Yellow (AlGaInP)	Unit
Reverse Voltage	$V_{\mathrm{R}}$	5	V
Forward Current	$I_{\rm F}$	30	mA
Forward Current (Peak) 1/10 Duty Cycle 0.1ms Pulse Width	$i_{\rm FS}$	175	mA
Power Dissipation	$P_{D}$	75	mW
Operating Temperature	TA	$-40 \sim +85$	°C
Storage Temperature	Tstg	$-40 \sim +85$	

A Relative Humidity between 40% and 60% is recommended in ESD-protected work areas to reduce static build up during assembly process (Reference JEDEC/JESD625-A and JEDEC/J-STD-033)

Part

Number

XZFMYK05A2

Operating Characteristics (T <sub>A</sub> =25°C)		Yellow (AlGaInP)	Unit
Forward Voltage (Typ.) (I <sub>F</sub> =10mA)	$V_{\rm F}$	1.95	V
Forward Voltage (Max.) (I <sub>F</sub> =10mA)	$V_{\rm F}$	2.35	V
Reverse Current (Max.) (V <sub>R</sub> =5V)	$I_R$	10	μΑ
Wavelength of Peak Emission CIE127-2007* (Typ.) (I <sub>F</sub> =10mA)	λP	590*	nm
Wavelength of Dominant Emission CIE127-2007* (Typ.) (I <sub>F</sub> =10mA)	λD	590*	nm
Spectral Line Full Width At Half-Maximum (Typ.) (I <sub>F</sub> =10mA)	$ riangle\lambda$	20	nm
Capacitance (Typ.) (V <sub>F</sub> =0V, f=1MHz)	С	20	pF
Luminous Intensity Wavelength CIE127-2007* CIE127-2007 (I <sub>F</sub> =10mA) ucd nm λP		Description	
min. typ.			
21000 49990 5600* 14990* 590*		Common Anode Rt.Hand Decima	, ,

\*Luminous intensity value and wavelength are in accordance with CIE127-2007 standards. Mar 06,2023

Emitting

Color

Yellow

Emitting

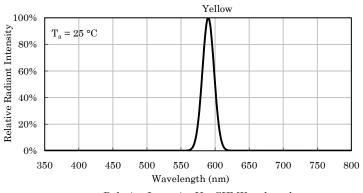
Material

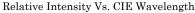
AlGaInP

XDSA9210 V11-X Layout: Maggie L.

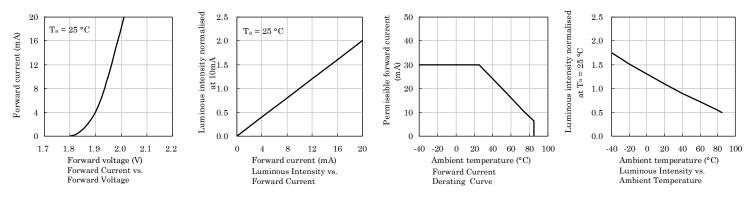


### Surface Mount Display





Yellow



## LED is recommended for reflow soldering and soldering profile is shown below.

300 above 255°C (°C) 260°C max. 30s max. 10s max. 250 3°C/s max. 6°C/s max 200 150 Temperature pre-heating 100 150~200°C above 217°C 60~150s 60~120s 50 25°C 0 0 50 100 150 200 250 300 (sec)Time Notes:

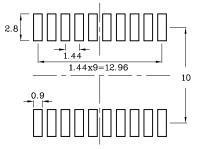
Reflow Soldering Profile for SMD Products (Pb-Free Components)

1. All temperatures refer to the center of the package,

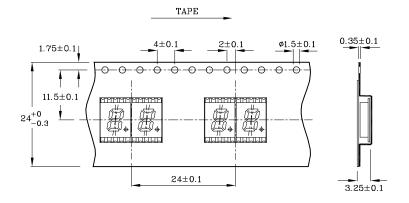
measured on the package body surface facing up during reflow. Do not apply any stress to the LED during high temperature conditions.
Maximum number of soldering passes: 2



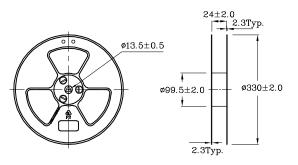
# **Recommended Soldering Pattern (Units : mm; Tolerance: ±0.15)**



# Tape Specification (Units : mm)



Reel Dimension (Units : mm)



#### Remarks:

If special sorting is required (e.g. binning based on forward voltage, Luminous intensity / luminous flux, or wavelength), the typical accuracy of the sorting process is as follows:

1. Wavelength: +/-1nm

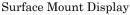
2. Luminous intensity / luminous flux: +/-15\%

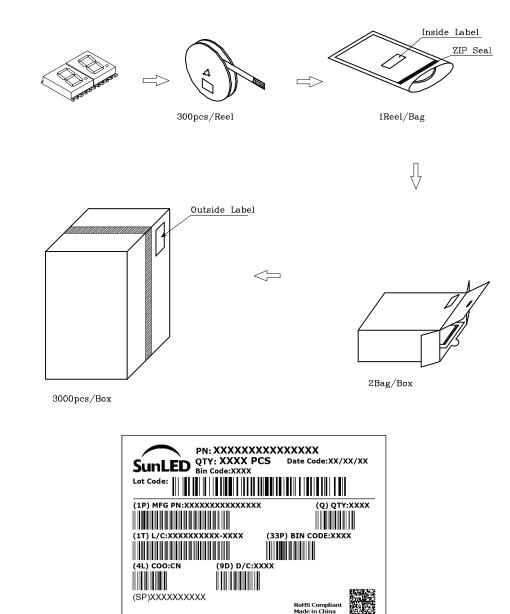
3. Forward Voltage: +/-0.1V

Note: Accuracy may depend on the sorting parameters.



PACKING & LABEL SPECIFICATIONS





### TERMS OF USE

- 1. Data presented in this document reflect statistical figures and should be treated as technical reference only.
- 2. Contents within this document are subject to improvement and enhancement changes without notice.
- 3. The product(s) in this document are designed to be operated within the electrical and environmental specifications indicated on the datasheet. User accepts full risk and responsibility when operating the product(s) beyond their intended specifications.
- 4. The product(s) described in this document are intended for electronic applications in which a person's life is not reliant upon the LED. Please consult with a SunLED representative for special applications where the LED may have a direct impact on a person's life.
- 5. The performance of the product(s) should be evaluated and verified by the customer to ensure it can meet the customer's application requirements.
- 6. The contents within this document may not be altered without prior consent by SunLED.
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- 8. Additional technical notes are available at https://www.SunLEDusa.com/TechnicalNotes.asp